

# UNISONIC TECHNOLOGIES CO., LTD

UTT108N03 Power MOSFET

## 30V, 108A N-CHANNEL POWER MOSFET

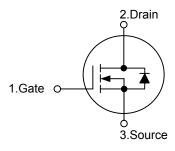
#### ■ DESCRIPTION

As advanced N-channel level power MOSFET, the **UTT108N03** is produced using UTC's advanced trench technology, which has been specially tailored to minimize the on-resistance and maintain low gate charge for superior switching performance.

#### ■ FEATURES

- \*  $R_{DS(ON)}$  = 6.0m $\Omega$  @ $V_{GS}$  = 10V
- \* Low Capacitance
- \* Optimized Gate Charge
- \* Fast Switching Capability
- \* Avalanche Energy Specified

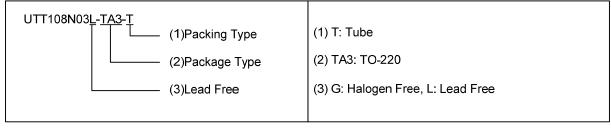
#### SYMBOL

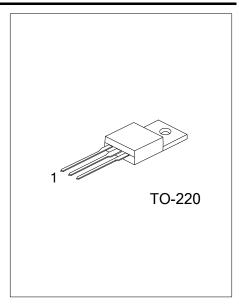


#### ORDERING INFORMATION

| Ordering Number  |                  | Dookogo | Pin Assignment |   |   | Dooking |  |
|------------------|------------------|---------|----------------|---|---|---------|--|
| Lead Free        | Halogen Free     | Package | 1              | 2 | 3 | Packing |  |
| UTT108N03L-TA3-T | UTT108N03G-TA3-T | TO-220  | G              | D | S | Tube    |  |

Note: Pin Assignment: G: Gate D: Drain S: Source





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## ■ ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> =25°C, unless otherwise specified)

| PARAMETER                     | SYMBOL           | RATINGS    | UNIT |
|-------------------------------|------------------|------------|------|
| Drain-Source Voltage          | $V_{DSS}$        | 30         | V    |
| Gate-Source Voltage           | V <sub>GSS</sub> | ±20        | V    |
| Drain Current                 | I <sub>D</sub>   | 108        | Α    |
| Pulsed Drain Current (Note 2) | I <sub>DM</sub>  | 432        | Α    |
| Avalanche Energy (Note 3)     | E <sub>AS</sub>  | 580        | mJ   |
| Power Dissipation             | P <sub>D</sub>   | 107        | W    |
| Junction Temperature          | $T_J$            | +175       | °C   |
| Strong Temperature            | T <sub>STG</sub> | -55 ~ +175 | °C   |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. t<sub>P</sub>≤10µs, pulsed, Ta=25°C
- 3.  $V_{GS}$ =10V,  $T_J$ =25°C, ID=35A,  $V_S$ ≤25V,  $t_p$ =0.25ms,  $R_{GS}$ =50 $\Omega$

#### ■ THERMAL DATA

| PARAMETER           | SYMBOL        | RATINGS | UNIT  |
|---------------------|---------------|---------|-------|
| Junction to Ambient | $\theta_{JA}$ | 62.5    | °C /W |
| Junction to Case    | $\theta_{JC}$ | 1.4     | °C /W |

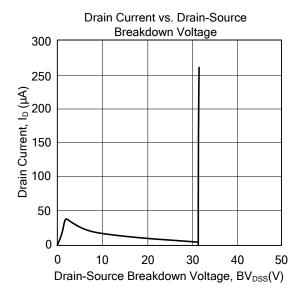
### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub> =25°C, unless otherwise specified)

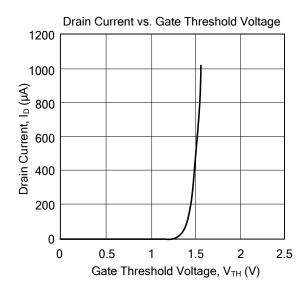
| PARAMETER                          | SYMBOL              | TEST CONDITIONS                                     | MIN | TYP  | MAX  | UNIT |
|------------------------------------|---------------------|---|-----|------|------|------|
| OFF CHARACTERISTICS                |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | $V_{GS}$ =0V, $I_D$ =250 $\mu$ A                    | 30  |      |      | V    |
| Drain-Source Leakage Current       | I <sub>DSS</sub>    | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V           |     | 0.05 | 1    | μΑ   |
| Gate-Source Leakage Current        | I <sub>GSS</sub>    | $V_{DS}$ =0V, $V_{GS}$ =±20V                        |     | 0.02 | 100  | nA   |
| ON CHARACTERISTICS                 |                     |   |     |      |      |      |
| Gate Threshold Voltage             | $V_{GS(TH)}$        | $V_{DS}=V_{GS}$ , $I_{D}=1mA$                       | 1   |      | 3    | V    |
| Static Drain-Source On-Resistance  | _                   | $V_{GS}$ =10V, $I_D$ =25A                           |     | 4.2  | 5.3  | mΩ   |
| Static Drain-Source On-Resistance  | R <sub>DS(ON)</sub> | $V_{GS}$ =5V, $I_D$ =25A                            |     |      | 6.6  | mΩ   |
| DYNAMIC PARAMETERS                 |                     |   |     |      |      |      |
| Input Capacitance                  | C <sub>ISS</sub>    |   |     | 3200 |      | pF   |
| Output Capacitance                 | Coss                | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz |     | 580  |      | pF   |
| Reverse Transfer Capacitance       | C <sub>RSS</sub>    |   |     | 400  |      | pF   |
| SWITCHING PARAMETERS               |                     |   |     |      |      |      |
| Total Gate Charge                  | $Q_G$               |   |     | 56   |      | nC   |
| Gate Source Charge                 | $Q_GS$              | $V_{DD}$ =15V, $V_{GS}$ =5V, $I_{D}$ =40A           |     | 16   |      | nC   |
| Gate Drain Charge                  | $Q_{GD}$            |   |     | 14   |      | nC   |
| Turn-ON Delay Time                 | t <sub>D(ON)</sub>  |   |     | 24   |      | ns   |
| Turn-ON Rise Time                  | t <sub>R</sub>      | $V_{DD}$ =15V, $R_{G}$ =10 $\Omega$ , $V_{GS}$ =5V, |     | 102  |      | ns   |
| Turn-OFF Delay Time                | t <sub>D(OFF)</sub> | $R_D=0.6\Omega$                                     |     | 53   |      | ns   |
| Turn-OFF Fall-Time                 | t <sub>F</sub>      |   |     | 54   |      | ns   |
| SOURCE- DRAIN DIODE RATINGS AND C  | HARACTER            | RISTICS   |     |      |      |      |
| Drain-Source Diode Forward Voltage | $V_{SD}$            | I <sub>S</sub> =108A, V <sub>GS</sub> =0 V          |     |      | 1.25 | V    |
| Maximum Pulsed Drain-Source Diode  |                     | (Note)  |     |      | 432  | ۸    |
| Forward Current                    | I <sub>SM</sub>     | (Note)  |     |      | 432  | Α    |
| Body Diode Reverse Recovery Time   | t <sub>RR</sub>     | I <sub>S</sub> =20A, dI <sub>S</sub> /dt=-100A/μs,  |     | 34   |      | ns   |
| Body Diode Reverse Recovery Charge | $Q_{RR}$            | V <sub>GS</sub> =0V                                 |     | 27   |      | nC   |

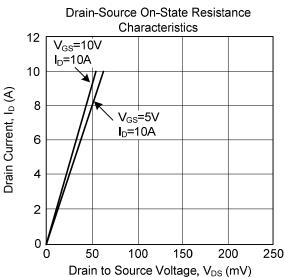
Note: t<sub>P</sub>≤10µs, pulsed

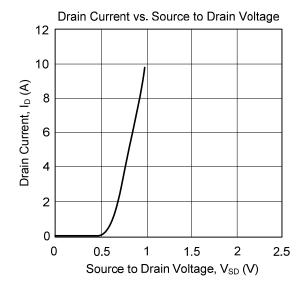
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#### ■ TYPICAL CHARACTERISTICS









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